# 8-215570-0 ACTIVE

## Micro-MaTch | Micro-MaTch Industrial

TE Internal #: 8-215570-0

PCB Mount Paddleboard Connector, Vertical, Cable-to-Board, 10 Position, .05 in [1.27 mm] Centerline, Ribbon Cable, Micro-MaTch

Industrial

View on TE.com >



Connectors > PCB Connectors > Board-In Connectors > Paddle Board Connector



PCB Connector Assembly Type: PCB Mount Paddleboard Connector

PCB Mount Orientation: Vertical
Connector System: Cable-to-Board

Number of Positions: 10

Centerline (Pitch): 1.27 mm [ .05 in ]

All Paddle Board Connector (20)

#### **Features**

## **Product Type Features**

| PCB Connector Assembly Type       | PCB Mount Paddleboard Connector     |
|-----------------------------------|-------------------------------------|
| Connector System                  | Cable-to-Board                      |
| Connector & Contact Terminates To | Printed Circuit Board, Wire & Cable |

## **Configuration Features**

| Wire Entry Location               | Тор          |
|-----------------------------------|--------------|
| PCB Mount Orientation             | Vertical     |
| Number of Positions               | 10           |
| Compatible With Wire & Cable Type | Ribbon Cable |
| Number of Rows                    | 2            |

#### **Electrical Characteristics**

| Insulation Resistance | 1000 MΩ |
|-----------------------|---------|
| Operating Voltage     | 100 VAC |

## **Body Features**

## **Contact Features**

| PCB Contact Termination Area Plating Material Thickness 3 – 5 µm[118.11 – 196.85 µin] |
|---|
|---|



| Wire Contact Termination Area Plating Thickness       | 1 μm[39.37 μin]                            |
|---|--|
| Wire Contact Termination Area Plating Material Finish | Matte                                      |
| Wire Contact Termination Area Plating Material        | Tin  |
| PCB Contact Termination Area Plating Material Finish  | Matte                                      |
| Contact Underplating Material                         | Nickel                                     |
| PCB Contact Termination Area Plating Material         | Tin  |
| Contact Base Material                                 | Phosphor Bronze                            |
| Contact Current Rating (Max)                          | 1.5 A                                      |
| Termination Features                                  |  |
| Rectangular Termination Post & Tail Thickness         | .5 mm[.02 in]                              |
| Rectangular Termination Post & Tail Width             | .4 mm[.015 in]                             |
| Termination Post & Tail Length                        | 3.2 mm[.125 in]                            |
| Termination Method to Printed Circuit Board           | Through Hole - Solder                      |
| Mechanical Attachment                                 |  |
| PCB Mount Retention Type                              | Kinked Solder Tails                        |
| PCB Mount Alignment                                   | With                                       |
| PCB Mount Retention                                   | With                                       |
| Housing Features                                      |  |
| Centerline (Pitch)                                    | 1.27 mm[.05 in]                            |
| Housing Material                                      | PBT GF                                     |
| Dimensions  |  |
| Connector Length                                      | 16.2 mm[.638 in]                           |
| Connector Height                                      | 5.1 mm[.2 in]                              |
| Row-to-Row Spacing                                    | 2 mm[.059 in]                              |
| Compatible Insulation Diameter Range                  | .8 – 1 mm[.035 – .039 in]                  |
| Wire Size   | .08 – .09 mm²                              |
| Usage Conditions                                      |  |
|   |  |
| Operating Temperature Range                           | -40 - 105 °C[-40 - 221 °F]                 |
| Operating Temperature Range  Operation/Application    | -40 - 105 °C[-40 - 221 °F]                 |
|   | -40 – 105 °C[-40 – 221 °F]  Board Standoff |
| Operation/Application                                 |  |



| Approved Standards     | UL E28476   |
|------------------------|-------------|
| UL Flammability Rating | UL 94V-0    |
| Packaging Features     |             |
| Packaging Quantity     | 250         |
| Packaging Type         | Box, Carton |

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU                  | Compliant   |
|---|---|
| EU ELV Directive 2000/53/EC                   | Compliant   |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold   |
| EU REACH Regulation (EC) No. 1907/2006        | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC |
| Halogen Content                               | Not Low Halogen - contains Br or Cl > 900 ppm.  |
| Solder Process Capability                     | Wave solder capable to 265°C  |

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## Compatible Parts







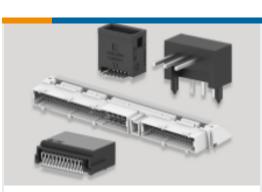




## Also in the Series | Micro-MaTch Industrial









Board-In Connectors(20)

Insertion & Extraction Tools(1)

PCB Headers & Receptacles(1)

Pluggable I/O Cable Assemblies(52)







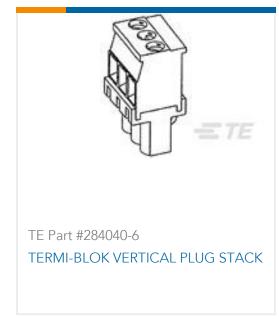
Wire-to-Board Connector Contacts(4)

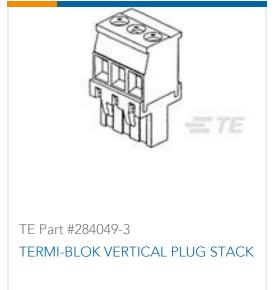
## Customers Also Bought

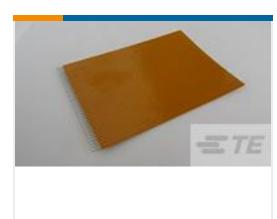


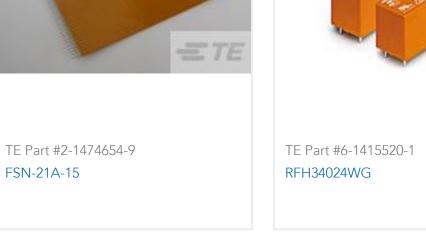
















#### **Documents**

## **Product Drawings**

MICRO-MATCH PBC.10P

English

**CAD Files** 

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_8-215570-0\_S.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_8-215570-0\_S.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_8-215570-0\_S.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

## Datasheets & Catalog Pages

Micro-MaTch Catalog

English

Ribbon Cable Interconnect Solutions

English

Centerline Micro-Match Connector Series

English

## **Product Specifications**

Application Specification

English

micro match miniature connector system

English

**Product Environmental Compliance** 

MD\_8-215570-0\_041720151020\_dmtec

English

MD\_8-215570-0\_041720151020\_dmtec

English